MOSFET – N-Channel, POWERTRENCH[®]

150 V, 169 A, 6.3 m Ω

FDBL86210-F085

Features

- Typical $r_{DS(on)} = 5 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 80 \text{ A}$
- Typical $Q_{g(tot)} = 70 \text{ nC}$ at $V_{GS} = 10 \text{ V}$, $I_D = 80 \text{ A}$
- UIS Capability
- AEC-Q101 Qualified and PPAP Capable
- This Device is Pb-Free and are RoHS Compliant

Applications

- Automotive Engine Control
- PowerTrain Management
- Solenoid and Motor Drivers
- Integrated Starter/Alternator
- Primary Switch for 12 V Systems

MOSFET MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Symbol	Parameter	Ratings	Unit
V _{DSS}	Drain to Source Voltage	150	V
V _{GS}	Gate to Source Voltage	±20	V
Ι _D	Drain Current – Continuous (V_{GS} = 10), T_{C} = 25°C (Note 1)	169	A
	Pulsed Drain Current, $T_C = 25^{\circ}C$	See Figure 4	
E _{AS}	Single Pulse Avalanche Energy (Note 2)	502	mJ
PD	Power Dissipation	500	W
	Derate Above 25°C	3.3	W/°C
T _J , T _{STG}	Operating and Storage Temperature	–55 to +175	°C
$R_{\theta JC}$	Thermal Resistance Junction to Case	0.3	°C/W
$R_{ heta JA}$	Maximum Thermal Resistance Junction to Ambient (Note 3)	43	°C/W

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

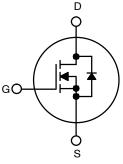
1. Current is limited by silicon.

- 2. Starting $T_J = 25^{\circ}$ C, L = 0.24 mH, $I_{AS} = 64$ A, $V_{DD} = 100$ V during inductor charging and $V_{DD} = 0$ V during time in avalanche.
- 3. R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design, while R_{0JA} is determined by the user's board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.



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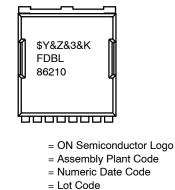


N-Channel



H-PSOF8L CASE 100CU

MARKING DIAGRAM



AN FDBL86210

\$Y

&Z

&3

&K

= Specific Device Code

ORDERING INFORMATION

[Device	Top Mark	Package	Shipping [†]
FDE -FC		FDBL86210	H-PSOF8L	2000 Units/ Tape&Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_{.1} = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
OFF CHARAC	CTERISTICS	•					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \ \mu A, V_G$	_S = 0 V	150	-	-	V
I _{DSS}	Drain to Source Leakage Current	$ \begin{array}{l} V_{DS} = 150 \mbox{ V}, \\ V_{GS} = 0 \mbox{ V} \end{array} \begin{array}{c} T_J = 25^{\circ} C \\ T_J = 175^{\circ} C \mbox{ (Note 4)} \end{array} $	-	-	1	μΑ	
			T _J = 175°C (Note 4)	-	-	1	mA
I _{GSS}	Gate to Source Leakage Current	V _{GS} = ±20 V		-	-	±100	nA
ON CHARAC	TERISTICS						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$		2.0	2.8	4.0	V
r _{DS(on)}	Drain to Source On Resistance	I _D = 80 A, V _{GS} = 10 V	$T_J = 25^{\circ}C$	-	5	6.3	mΩ
			T _J = 175°C (Note 4)	-	14	17.5	mΩ
OYNAMIC CH	IARACTERISTICS						
C _{iss}	Input Capacitance	V _{DS} = 75 V, V _{GS} = 0 V, f = 1 MHz		-	5805	-	pF
C _{oss}	Output Capacitance			-	536	-	pF
C _{rss}	Reverse Transfer Capacitance			-	16	-	pF
Rg	Gate Resistance	f = 1 MHz		-	2.2	-	Ω
Q _{g(ToT)}	Total Gate Charge at 10 V	V _{GS} = 0 to 10 V	V _{DD} = 75 V,	-	70	90	nC
Q _{g(th)}	Threshold Gate Charge	V_{GS} = 0 to 2 V	= 0 to 2 V I _D = 80 A		10.5	13	nC
Q _{gs}	Gate to Source Gate Charge	V _{DD} = 75 V, I _D = 80 A		-	32.5	-	nC

SWITCHING CHARACTERISTICS

Gate to Drain "Miller" Charge

Q_{gd}

t	on	Turn-On Time	$V_{DD} = 75 V, I_D = 80 A,$	-	-	80	ns
t _d ((on)	Turn-On Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$	-	39	-	ns
1	t _r	Rise Time		-	30	-	ns
t _d ((off)	Turn-Off Delay Time		-	70	-	ns
1	t _f	Fall Time		-	23	-	ns
t	off	Turn-Off Time		-	-	130	ns

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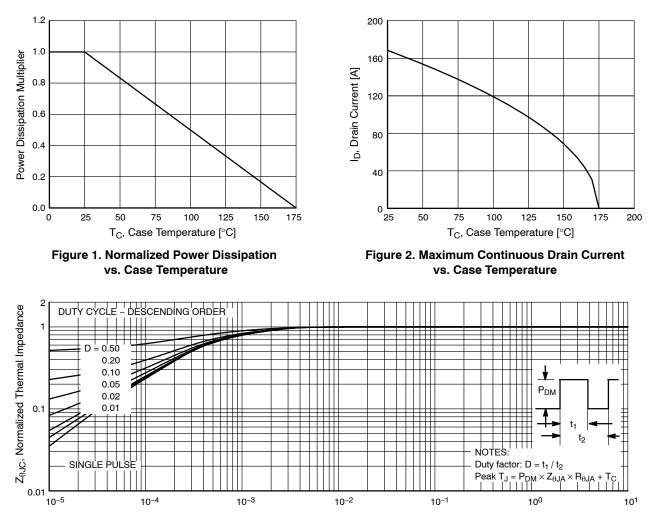
nC

DRAIN-SOURCE DIODE CHARACTERISTIC

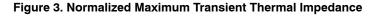
V	/ _{SD}	Source to Drain Diode Voltage	$I_{SD} = 80 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1.25	V
			I_{SD} = 40 A, V_{GS} = 0 V	-	-	1.2	V
٦	T _{rr}	Reverse Recovery Time	$I_{F} = 80 \text{ A}, \text{ dI}_{SD}/\text{dt} = 100 \text{ A}/\mu\text{s},$	-	108	125	ns
(ຊ _{rr}	Reverse Recovery Charge	V _{DD} = 120 V	-	323	467	nC

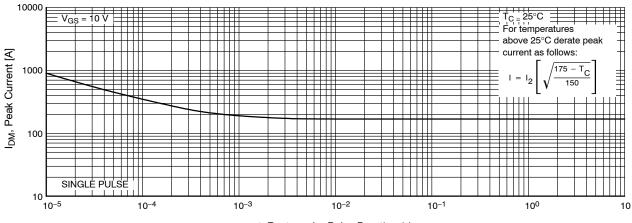
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. The maximum value is specified by design at $T_J = 175^{\circ}$ C. Product is not tested to this condition in production.

TYPICAL CHARACTERISTICS



t, Rectangular Pulse Duration (s)





t, Rectangular Pulse Duration (s)

Figure 4. Peak Current Capability

TYPICAL CHARACTERISTICS (continued)

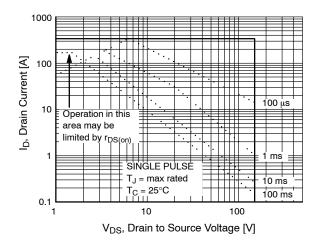


Figure 5. Forward Bias Safe Operating Area

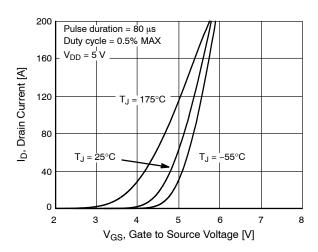


Figure 7. Transfer Characteristics

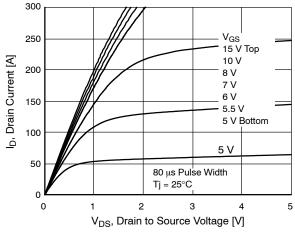


Figure 9. Saturation Characteristics

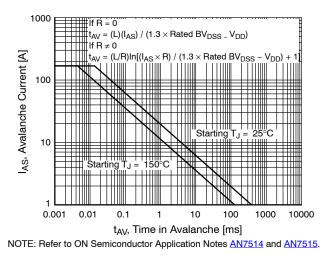


Figure 6. Unclamped Inductive Switching Capability

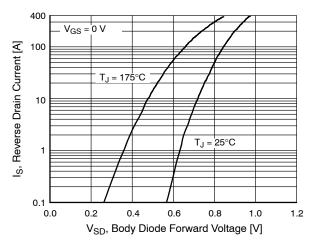


Figure 8. Forward Diode Characteristics

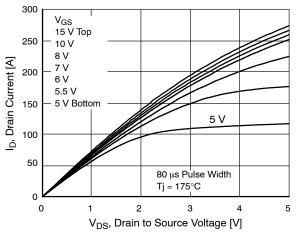
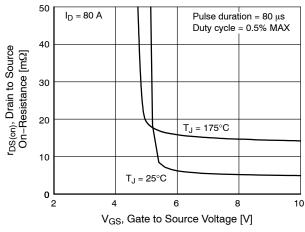
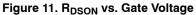


Figure 10. Saturation Characteristics

TYPICAL CHARACTERISTICS (continued)





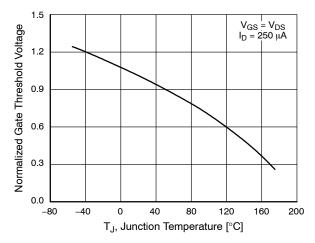


Figure 13. Normalized Gate Threshold Voltage vs. Temperature

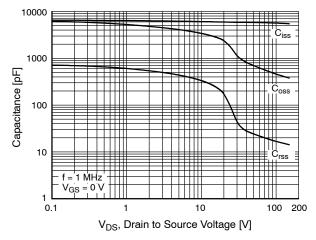


Figure 15. Capacitance vs. Drain to Source Voltage

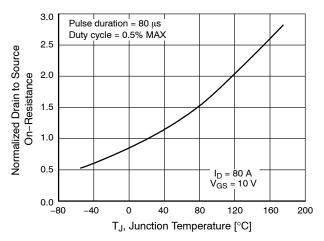


Figure 12. Normalized R_{DSON} vs. Junction Temperature

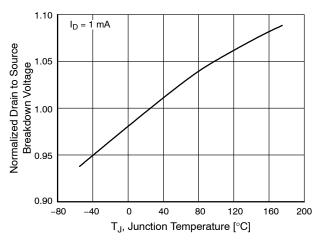


Figure 14. Normalized Drain to Source Breakdown Voltage vs. Junction Temperature

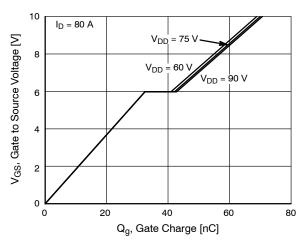
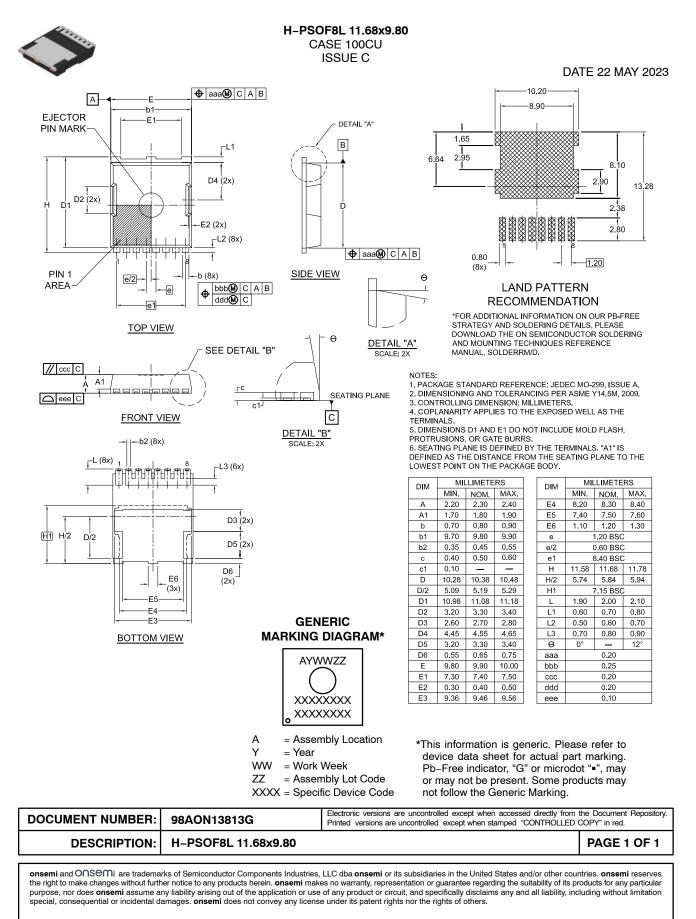


Figure 16. Gate Charge vs. Gate to Source Voltage

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